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FDBL86063-F085 N-Channel Power Trench[®] MOSFET 100 V, 240 A, 2.6 mΩ

Features

- Typical $R_{DS(on)}$ = 2 m Ω at V_{GS} = 10V, I_D = 80 A
- Typical Q_{q(tot)} = 73 nC at V_{GS} = 10V, I_D = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

Applications

- Automotive Engine Control
- Powertrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architect
- Primary Switch for 12V

| MOSFET Maximum Ratings | $T_{.1}$ = 25°C unless otherwise noted. |
|--|---|
| Primary Switch for 12V Systems | |
| Distributed Power Architectures and VR | M |

| Symbol | Parameter | | Ratings | Units |
|-----------------------------------|---|-----------------------|--------------|-------|
| V _{DSS} | Drain-to-Source Voltage | | 100 | V |
| V _{GS} | Gate-to-Source Voltage | | ±20 | V |
| I _D | Drain Current - Continuous (V _{GS} =10) (Note 1) | T _C =25°C | 240 | |
| | Pulsed Drain Current | T _C = 25°C | See Figure 4 | Α |
| E _{AS} | Single Pulse Avalanche Energy | (Note 2) | 160 | mJ |
| D | Power Dissipation | | 357 | W |
| P _D | Derate Above 25°C | | 2.38 | W/ºC |
| T _J , T _{STG} | Operating and Storage Temperature | | -55 to + 175 | °C |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 0.42 | °C/W |
| $R_{\theta JA}$ | Maximum Thermal Resistance, Junction to Ambient | (Note 3) | 43 | °C/W |

Package Marking and Ordering InformationNotes:

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|----------------|---------|-----------|------------|------------|
| FDBL86063 | FDBL86063-F085 | MO-299A | 13" | 24mm | 2000 units |

Notes:

1: Current is limited by bondwire configuration.

- 2: Starting T_J = 25°C, L = 500H, I_{AS} = 80A, V_{DD} = 100V during inductor charging and V_{DD} = 0V during time in avalanche. 3: $R_{\theta,JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design, while R_{0JA} is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

FDBL86063-F085 N-Channel Power Trench[®] MOSFET



| Symbol | Parameter | Test | t Conditions | Min. | Тур. | Max. | Units |
|-----------------------------------|-----------------------------------|--|------------------------------|------|------------|----------|-------|
| Off Cha | racteristics | | | | | | |
| B _{VDSS} | Drain-to-Source Breakdown Voltage | I _D = 250μA, V | V _{GS} = 0V | 100 | - | - | V |
| | Drain-to-Source Leakage Current | V _{DS} =100V | | - | - | 1 | μA |
| IDSS | Drain-to-Source Leakage Current | $V_{GS} = 0V$ | $T_{\rm J}$ = 175°C (Note 4) | - | - | 1.5 | mA |
| I _{GSS} | Gate-to-Source Leakage Current | $V_{GS} = \pm 20V$ | | - | - | ±100 | nA |
| $V_{GS(th)}$ | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I$ $I_D = 80A$ | | 2 | 2.9 2.0 | 4 2.6 | mΩ |
| On Cha | racteristics | | | | | | |
| rDS(on) | Drain-to-Source On-Resistance | - | - | - | - | | mΩ |
| 120(01) | | V _{GS} = 10V | $T_{\rm J}$ = 175°C (Note 4) | - | 4.2 | 5.6 | mΩ |
| Dynami C _{iss} | c Characteristics | | /0\/ | - | 5120 | - | pF |
| C _{oss} | Output Capacitance | — V _{DS} = 50V, V _{GS} = 0V, — f = 1MHz | | - | 3220 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | | | - | 32 | - | pF |
| Rg | Gate Resistance | V _{GS} = 0.5V, | | - | 0.4 | - | Ω |
| Q _{g(ToT)} | Total Gate Charge | V _{GS} = 0 to 1 | 0V | - | 73 | 95 | nC |
| Q _{g(th)} | Threshold Gate Charge | $V_{GS} = 0$ to 2 | V | - | 9 | - | nC |
| Q _{gs} | Gate-to-Source Gate Charge | V _{DD} = 50V,I _C | =804 | - | 22 | - | nC |
| 3- | Gate-to-Drain "Miller" Charge | VDD - 50 V,IC |) -00A | | 17 | _ | nC |

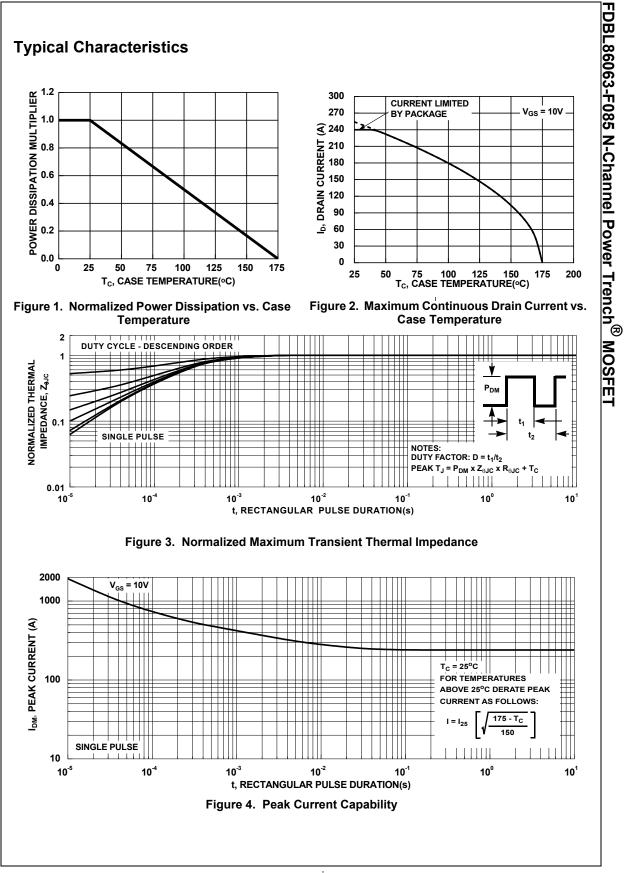
| t _{on} | Turn-On Time | | - | - | 53 | ns |
|---------------------|----------------|---|---|----|----|----|
| t _{d(on)} | Turn-On Delay | | - | 25 | - | ns |
| t _r | Rise Time | V _{DD} = 50V, I _D = 80A | - | 16 | - | ns |
| t _{d(off)} | Turn-Off Delay | $V_{DD} = 50V, I_D = 80A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$ | - | 32 | - | ns |
| t _f | Fall Time | | - | 8 | - | ns |
| t _{off} | Turn-Off Time | | - | - | 51 | ns |

Drain-Source Diode Characteristics

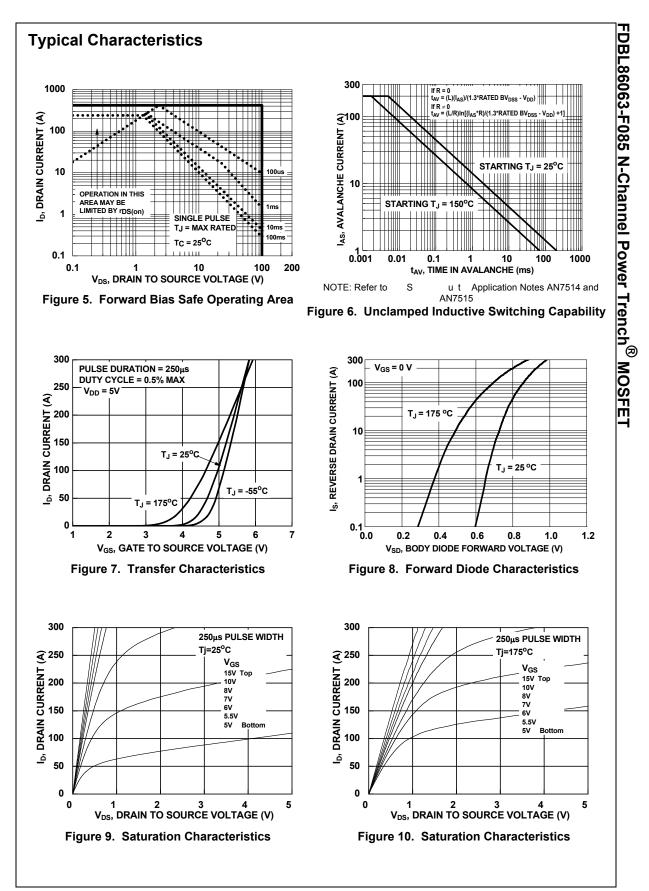
| V Source to Drain Diede Voltage | I _{SD} =80A, V _{GS} = 0V | - | 0.9 | 1.25 | V | |
|---------------------------------|---|--|-----|------|-----|----|
| ▼ SD | V _{SD} Source-to-Drain Diode Voltage | I_{SD} = 40A, V_{GS} = 0V | - | 0.8 | 1.2 | V |
| t _{rr} | Reverse-Recovery Time | I _F = 80A, dI _{SD} /dt = 100A/μs | - | 107 | 139 | ns |
| Q _{rr} | Reverse-Recovery Charge | $F = 80A$, $di_{SD}/dt = 100A/\mu s$ | - | 175 | 260 | nC |

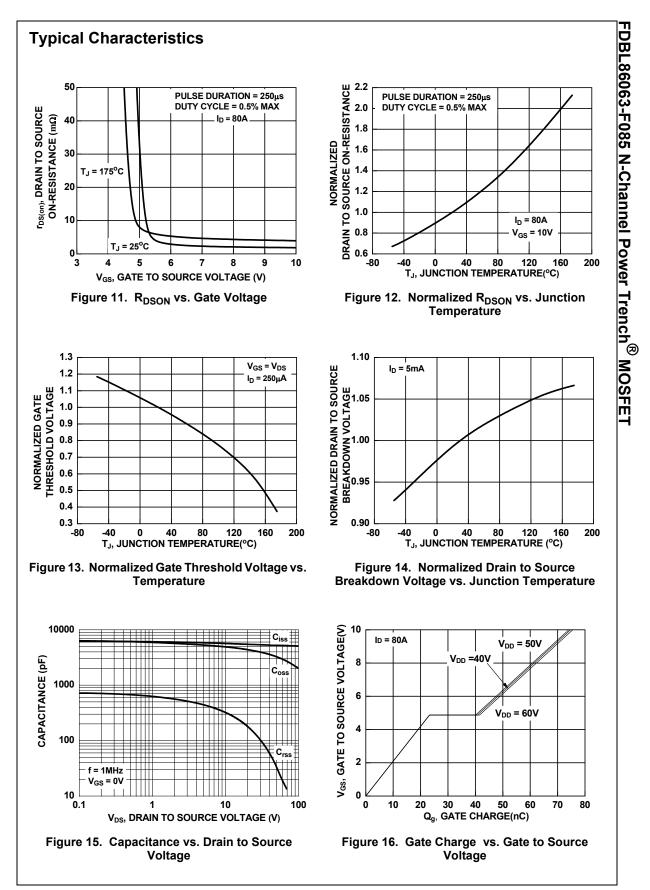
Note:

4: The maximum value is specified by design at T_J = 175°C. Product is not tested to this condition in production.



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